

# Vrushabh Vakhare

+91 7383975075 | [Vrushabhvakhare22@gmail.com](mailto:Vrushabhvakhare22@gmail.com)  
Surat, Gujarat, India 394210  
<https://www.linkedin.com/in/vrushabh-vakhare-79081a18b/>

## ASIC PHYSICAL DESIGN ENGINEER

ASIC Design Expertise: Skilled in designing and optimizing integrated circuits, with proficiency in complex chip blocks, floor planning, power optimization, and timing closure. Proven ability to deliver high-quality designs on schedule, ensuring performance and manufacturability.

## PROFESSIONAL SKILLS

Operating Systems	Windows/Linux
Scripting Language	TCL, Shell, Perl, Make
Place and Route	Synopsys ICC2, Synopsys Fusion Compiler
Static-Timing Analysis	Synopsys Prime Time
RC Extraction	Synopsys Star-RC
IR Analysis	Ansysis Redhawk-SC
Physical Verification	Siemens calibre

## PROFESSIONAL EXPERIENCE

### Einfochips (An Arrow Company)

ASIC Physical Design Engineer

Aug 2021 – Present

- More than 3 years of experience in ASIC Physical Design implementation.
- Skilled in working with TSMC 5nm and 7nm technology nodes.
- Familiar with all phases of Physical Design Implementation such as Floor planning & Memory placement, Power Planning, Placement, Clock Tree Synthesis, Static Timing Analysis, Physical Verification, and Formal Verification.
- Successfully completed tape-out of several designs in 5nm and 7nm technologies.
- Coordinated with the RTL design team and DFT team to comprehend design requirements and ensure that design objectives for Power, Performance, and Area (PPA) were achieved.
- Consistently demonstrated an extraordinary level of dedication, giving 200% effort to ensure project goals were not just met, but exceeded.

### Einfochips (An Arrow Company)

ASIC Physical Design Engineer Trainee

Jan 2021 – July 2021

- Assisted physical design engineers with floor planning, power planning, and the placement of digital blocks.
- Learned to implement timing, power, and area constraints under the guidance of experienced team members.
- Worked on two training projects on 90nm technology.

## PROJECT DETAILS

### PROJECT 1

Networking Chip (DPU)

Technology

7 nm TSMC, 16 Metal Layers

Role

Physical Design and Signoff

Design Complexity

Multimillion Instance count, Timing, Congestion, Memory dominant blocks

Max Clock Freq.

~1.2 GHz.

Tools

ICC2 Compiler, Calibre, Synopsys Prime-Time

- Responsible and handling 3 blocks along with channel block activities from Netlist to GDSII with flow enhancement and block closure.
- Responsibilities include.
  - Netlist checks, Floorplan, Placement & optimization, Clock Tree Synthesis, Routing and optimization, extraction, Static Timing Analysis and closure, Formal verification, Physical verification, flow, and script improvements.
  - Checking timing, and congestion and resolved the overflow and timing issue.
  - Running signoff flow and fixing the timing, antenna, EM, IR, DRC, LVS, LEC.
- Challenges faced and resolved:
  - Efficiently managed the placement of 180-200 macros in high-density blocks, strategically positioning memory banks to optimize for signal fan-in and fan-out requirements.
  - Identified and resolved an issue with a high fanout register in the netlist, which was affecting 30% of the logic. This was accomplished based on feedback provided to the RTL design team, resulting in a 15% improvement in overall Timing.
  - Nail Down critical design timing operating at a frequency of 2 GHz within a 7.5-track cell height.

<b>PROJECT 2</b>	Networking Chip (DPU)
Technology	5nm TSMC, 18 Metal Layers
Role	Physical Design and Signoff
Design Complexity	Multimillion Instance count, Timing, Congestion, Memory dominant blocks
Max Clock Freq.	~1.2 GHz.
Tools	Fusion Compiler, Calibre, Synopsys Primetime

- Led physical design and signoff activities for High-Performance Computing ASICs, utilizing cutting-edge 5nm TSMC process technology with 18 metal layers.
- Oversaw the complete design flow for six blocks, from Netlist to GDSII implementation.
- Worked on a high-performance design with a focus on maximizing clock frequency, achieving a maximum frequency of approximately 1.2 GHz.
- Responsibilities included:
  - Netlist checks, Floorplan, Placement & optimization, Clock Tree Synthesis, Routing and optimization, Extraction, Static Timing Analysis and closure, Formal verification, Physical verification, Flow, and script improvements.
  - Implemented rigorous DRC and congestion management strategies to meet stringent design requirements.
  - Collaborated with methodology experts to adapt the 7nm Prime-Time/Star-RC flow to the 5nm.
  - Collaborated closely with a team of 5 designers to meet interface timing, achieving this goal 20% earlier than usual in the Place and Route (PNR) phase.

## EDUCATION & CERTIFICATIONS

**Bachelor's in engineering** - Power Electronics- Vishwakarma Government Engineering College

**Diploma in Engineering** - Power Electronics - Dr. S & S.S. Ghandhy College

**VLSI Training** - Physical Design - eInfochips Training & Research Academy Ltd

## APPRECIATIONS

Awarded Core Value Award for Continues learning.

Awarded Best Team of the Year for collaboration and contribution to project tap-out.

## PUBLICATIONS

- "Power Analysis in 7nm Technology Node", Published on Design & Reuse, 2023